Sheet 1 of 1

FORM PTO 1449 (*modified*)

U.S. DEPARTMENT OF COMMERCE
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LIST OF REFERENCES CITED BY APPLICANT(S)
(*Use several sheets if necessary*)

Date Submitted to PTO: November 19, 2003

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APPLICANT	
Hidenobu HAMADA	
FILING DATE	**GROUP**
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U.S. PATENT DOCUMENTS

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	AA						
	AB						
	AC						

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES	TRANSLATION NO
BMH	AD	63-33707	2/1988	JP	385	14X		
BMH	AE	2-244105	9/1990	JP	385	14X		
BMH	AF	2002-286952	10/2002	JP	385	14X		
BMH	AG	95/12828	5/1995	WO	385	14X	Abstract	
BMH	AH	8-201648	8/1996	JP	385	14X		
BMH	AI	11-109149	4/1999	JP	385	14X	Abstract	
	AJ							

OTHER DOCUMENT(S) (*Including Author, Title, Date, Pertinent Pages, Etc.*)

BMH	AK	F. Rottmann, A. Neyer, W. Mevenkamp, and E. Voges, "Integrated-Optic Wavelength Multiplexers on Lithium Niobate Based on Two-Mode Interference", Journal of Lightwave Technology, Vol. 6, No. 6, June 1988, pp. 946-953
BMH	AL	M. R. Paiam, C. F. Janz, R. I. MacDonald, J. N. Broughton, "Compact Planar 980/1550-nm Wavelength Multi-Demultiplexer Based on Multimode Interference", IEEE Photonics Technology Letters, Vol. 7, No. 10, October 1995, pp. 1180-1183
BMH	AM	K. C. Lin and W. Y. Lee, "Guided-wave 1.3/1.55 μm wavelength division multiplexer based on multimode interference", IEEE Electronics Letters, Vol. 32, No. 14, July 1996, pp. 1259-1261
BMH	AN	Baojun Li, Guozheng Li, Enke Liu, Zuimin Jiang, Jie Qin, and Xun Wang, "Low-Loss 1 x 2 Multimode Interference Wavelength Demultiplexer in Silicon-Germanium Alloy", IEEE Photonics Technology Letters, Vol. 11, No. 5, May 1999, pp. 575-577
	AO	

EXAMINER	B. Healy	DATE CONSIDERED	9/15/05

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.